APM2103SGC-TRL-VB Datasheet
Dual P-Channel 20-V (D-S) MOSFET

Features

- The APM2103SGC-TRL-VB incorporates a P-channel MOSFET that feature low ON-resistance and ultrahigh-speed switching, thereby enabling high-density mounting
- 1.8V drive
- Halogen free compliance
- Protection diode in

Specifications

Absolute Maximum Ratings at Ta=25°C

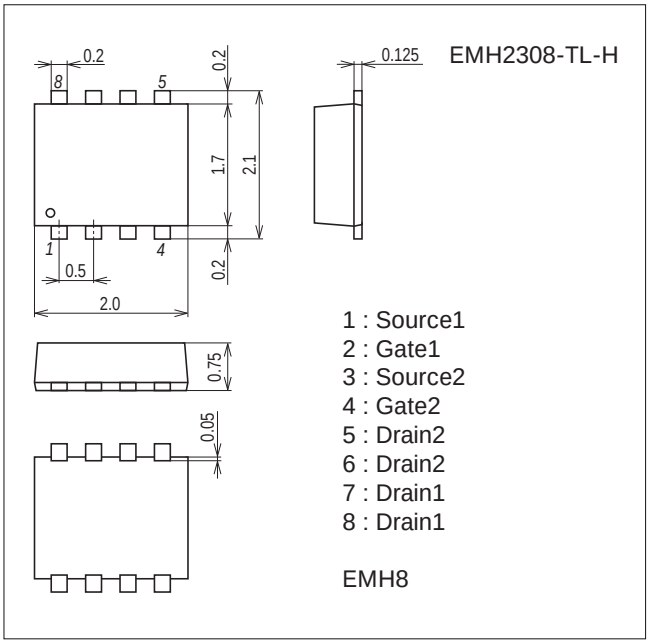
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		−20	V
Gate-to-Source Voltage	V_{GSS}		±12	V
Drain Current (DC)	I_D		-3.5	A
Drain Current (Pulse)	I_{DP}	PW≤10μs, duty cycle≤1%	-25	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate (900mm^2×0.8mm) 1unit	1.0	W
Total Dissipation	P_T	When mounted on ceramic substrate (900mm^2×0.8mm)	1.2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		−55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

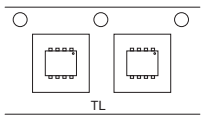
Package Dimensions

unit : mm (typ)

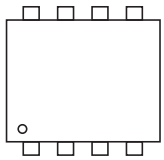
7045-002



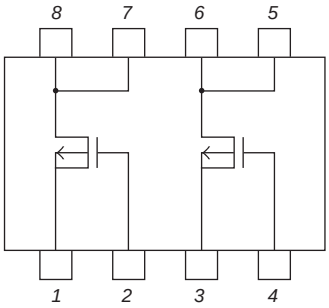
Packing Type : TL



Marking



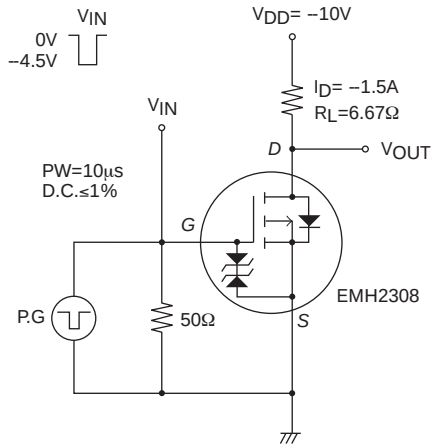
Electrical Connection



Electrical Characteristics at Ta=25°C

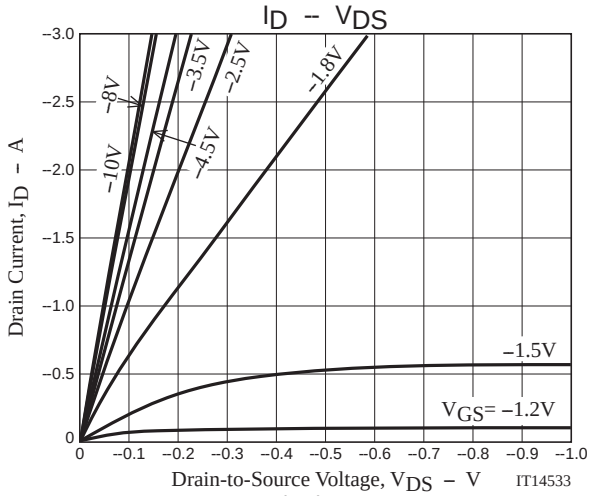
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=−1mA, V_{GS}=0V	−20			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=−20V, V_{GS}=0V			−1	μA
Gate-to-Source Leakage Current	I_{GSS}	V_{GS}=±8V, V_{DS}=0V			±10	μA
Cutoff Voltage	V_{GS}(off)	V_{DS}=−10V, I_D=−1mA	−0.4		−1.3	V
Forward Transfer Admittance	| yfs |	V_{DS}=−10V, I_D=−1.5A	2.1	3.6		S
Static Drain-to-Source On-State Resistance	R_{DS}(on)1	I_D=−3A, V_{GS}=−4.5V		65	85	mΩ
	R_{DS}(on)2	I_D=−1.0A, V_{GS}=−2.5V		98	137	mΩ
	R_{DS}(on)3	I_D=−0.5A, V_{GS}=−1.8V		155	235	mΩ
Input Capacitance	Ciss	V_{DS}=−10V, f=1MHz		320		pF
Output Capacitance	Coss			66		pF
Reverse Transfer Capacitance	Crss			50		pF
Turn-ON Delay Time	t_d(on)	See specified Test Circuit.		7.1		ns
Rise Time	t_r			21		ns
Turn-OFF Delay Time	t_d(off)			37		ns
Fall Time	t_f			32		ns
Total Gate Charge	Qg	V_{DS}=−10V, V_{GS}=−4.5V, I_D=−3A		4.0		nC
Gate-to-Source Charge	Qgs			0.6		nC
Gate-to-Drain “Miller” Charge	Qgd			1.1		nC
Diode Forward Voltage	V_{SD}	I_S=−3A, V_{GS}=0V		−0.83	−1.2	V

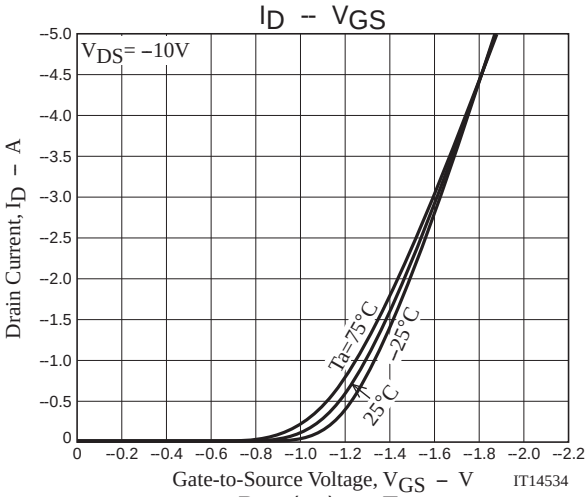
Switching Time Test Circuit

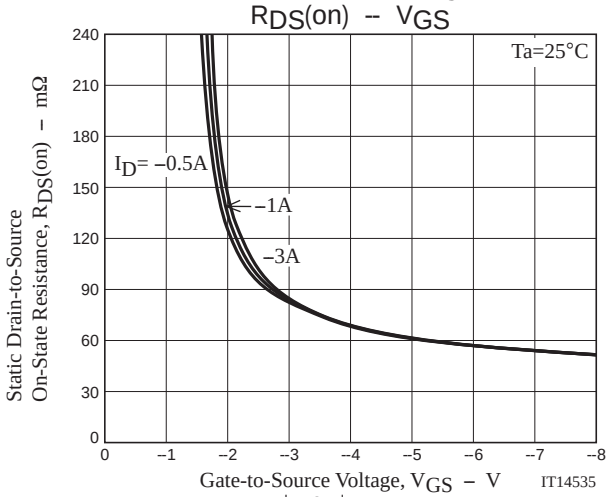


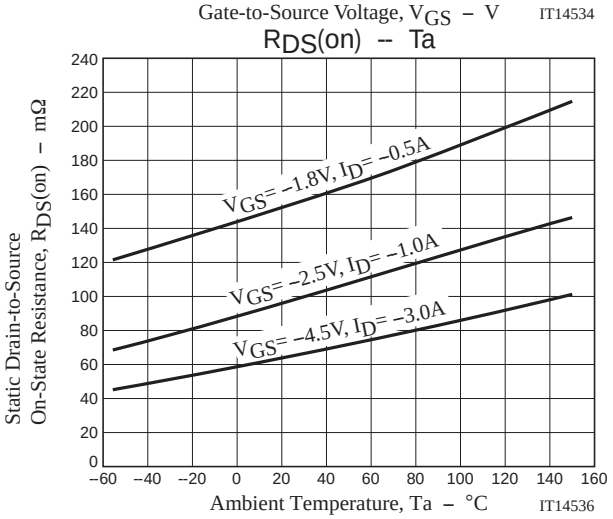
Ordering Information

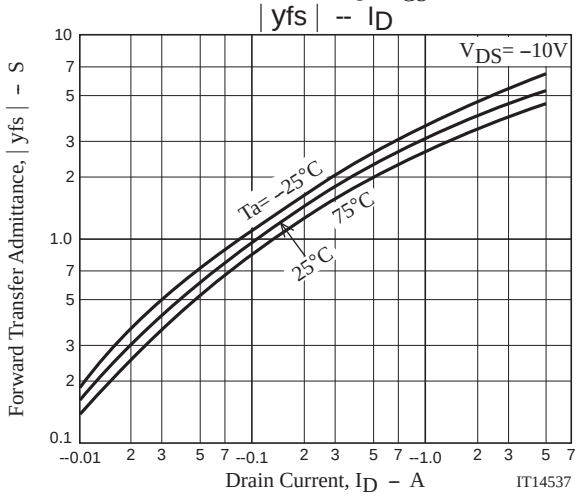
Device	Package	Shipping	memo
EMH2308-TL-H	EMH8	3,000pcs./reel	Pb Free and Halogen Free

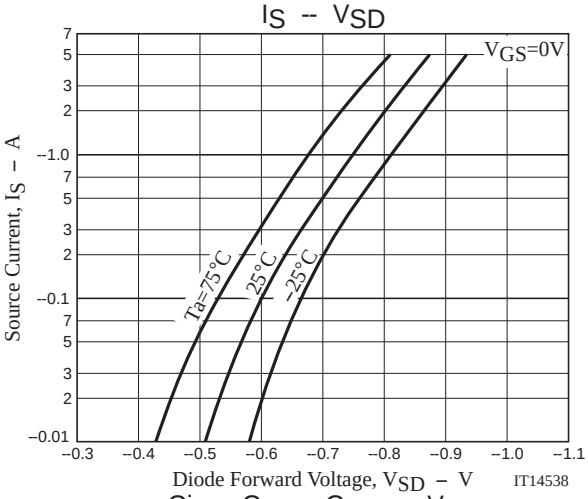

ID -- VDS
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT14533
–8V
–10V
–3.5V
–2.5V
–4.5V
–1.8V
–1.5V
VGS= –1.2V

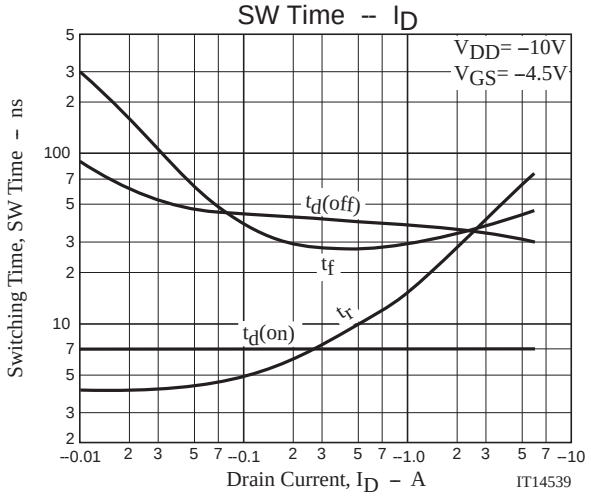

ID -- VGS
VDS= –10V
Drain Current, ID – A
Gate-to-Source Voltage, VGS – V
IT14534
Ta=75°C
25°C
–25°C

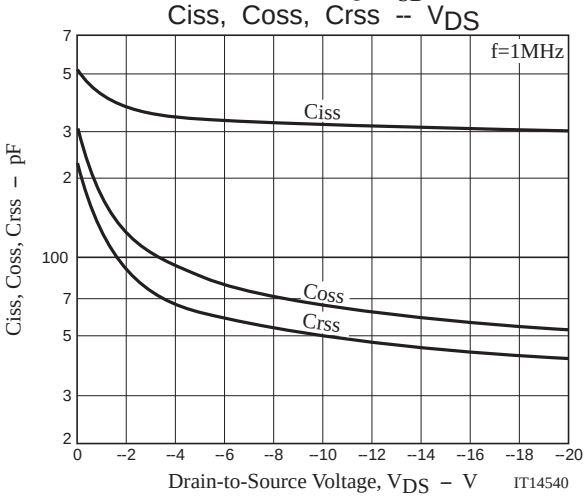

RDS(on) -- VGS
Ta=25°C
ID= –0.5A
–1A
–3A
Static Drain-to-Source On-State Resistance, RDS(on) – mΩ
Gate-to-Source Voltage, VGS – V
IT14535

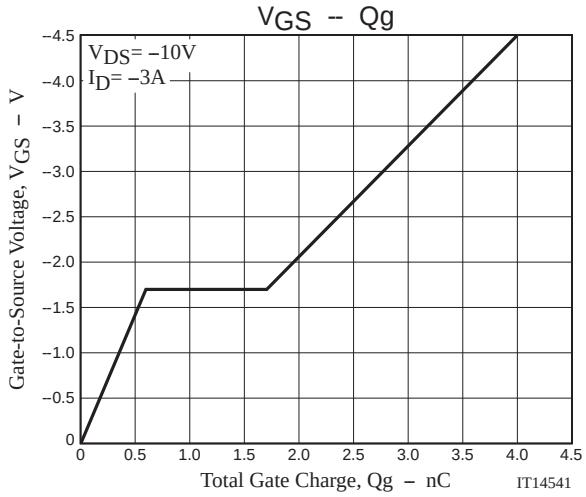

RDS(on) -- Ta
VGS= –1.8V, ID= –0.5A
VGS= –2.5V, ID= –1.0A
VGS= –4.5V, ID= –3.0A
Static Drain-to-Source On-State Resistance, RDS(on) – mΩ
Ambient Temperature, Ta – °C
IT14536

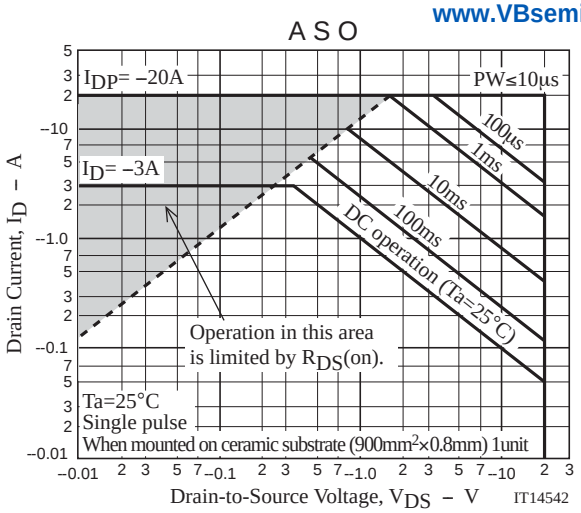

| yfs | -- ID
VDS= –10V
Ta= –25°C
75°C
25°C
Forward Transfer Admittance, | yfs | – S
Drain Current, ID – A
IT14537

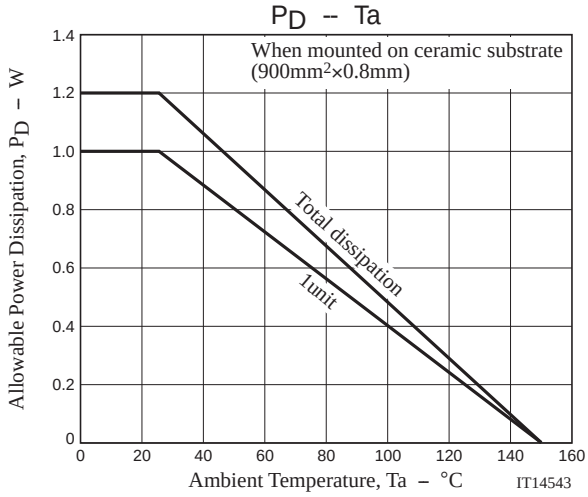

IS -- VSD
VGS=0V
Ta=75°C
25°C
–25°C
Source Current, IS – A
Diode Forward Voltage, VSD – V
IT14538


SW Time -- ID
VDD= –10V
VGS= –4.5V
td(off)
tf
tr
td(on)
Switching Time, SW Time – ns
Drain Current, ID – A
IT14539


Ciss, Coss, Crss -- VDS
f=1MHz
Ciss
Coss
Crss
Ciss, Coss, Crss – pF
Drain-to-Source Voltage, VDS – V
IT14540

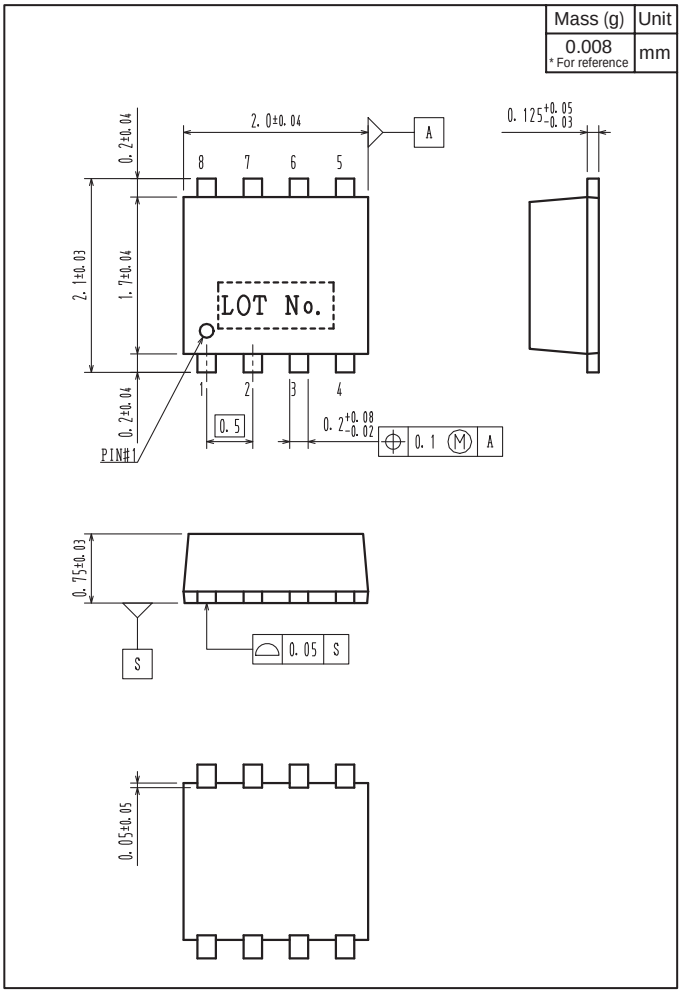

VGS – Qg
VDS= –10V
ID= –3A
Gate-to-Source Voltage, VGS – V
Total Gate Charge, Qg – nC
IT14541


A S O
IDP= –20A
PW≤10μs
ID= –3A
100μs
1ms
10ms
100ms
DC operation (Ta=25°C)
Operation in this area
is limited by RDS(on).
Ta=25°C
Single pulse
When mounted on ceramic substrate (900mm2×0.8mm) 1unit
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT14542

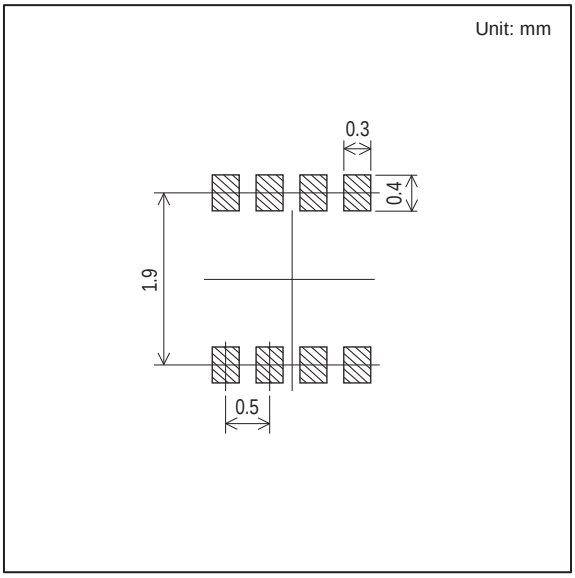

PD – Ta
When mounted on ceramic substrate
(900mm2×0.8mm)
Total dissipation
1unit
Allowable Power Dissipation, PD – W
Ambient Temperature, Ta – °C
IT14543

Outline Drawing

EMH2308-TL-H



Land Pattern Example



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